# 400 V／10 Ohm， General Purpose， 1 Form A， Solid State Relay 

## Technical Data

## Features

－Compact Solid－State Bidirectional Switch
－Normally－Off Single－Pole Relay Function（1 Form－A）
－ 400 V Output Withstand Voltage in Both Polarities at $25^{\circ} \mathrm{C}$
－150／300 mA Current Ratings （See Schematic for Connection A \＆B）
－Low Input Current；CMOS Compatibility
－Very Low On－Resistance： $6 \Omega$ Typical at $25^{\circ} \mathrm{C}$
－ac／dc Signal \＆Power Switching
－Input－to－Output Momentary Withstand Insulation Voltage： 2500 Vac， 1 Minute
－16－kV ESD Immunity：MIL－ STD－883，Method 3015
－CSA Approved
－UL 508 Recognized

## Applications

－Modems
－Telecommunication Switching Equipment
－Telecommunication Test Instruments
－Reed Relay Replacement
－110／220 Vac Load Driver
－Industrial Relay Coil Driver

## Description

The HSSR－8400 consists of a high－voltage circuit，optically coupled with a Light－Emitting Diode（LED）．This device is a solid－state replacement for single－ pole，normally－open（ 1 Form A） electromechanical relays used for general purpose switching of signals and low－power ac／dc loads．The relay turns on（contact closes）with a minimum input current， $\mathrm{I}_{\mathrm{F}}$ ，of 5 mA through the input LED．The relay turns off （contact opens）with an input voltage， $\mathrm{V}_{\mathrm{F}}$ ，of 0.8 V or less．The detector contains a high speed photosensitive FET driver circuit and two high voltage MOSFETs．

This relay＇s logic－level input con－ trol and very low typical output on－resistance of $6 \Omega$ make it suitable for switching of audio frequency signals in telecom applications．Connection A，as shown in the schematic，allows the relay to switch either ac or dc loads．In this configuration，the 150 mA output current rating allows it to switch small loads that are driven from 110 Vac and 220 Vac power lines．Connection B ，with the polarity and pin configuration as indicated in the schematic，allows the relay to

HSSR－8400
switch dc loads only．The advantage of Connection B is that the on－resistance is significantly reduced and the output current capability increases by a factor of two．

The electrical and switching characteristics of the HSSR－8400 are specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ．

## Functional Diagram



CONNECTION B
de CONNECTION


TRUTH TABLE （POSITIVE LOGIC）

| LED | OUTPUT |
| :---: | :---: |
| ON | L |
| OFF | H |

## Selection Guide

| $\begin{aligned} & \text { 6-Pin DIP } \\ & \text { (300 Mil) } \end{aligned}$ | $\begin{aligned} & \text { 4-Pin DIP } \\ & \text { (300 Mil) } \end{aligned}$ | Maximum Speed t(ON) msec $25^{\circ} \mathrm{C}$ | Maximum ON Resistance | Maximum Output Voltage | Maximum Output Current | Minimum <br> Input <br> Current <br> mA | Hermetic 8-Pin |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Single | Dual |  | R(ON) | VO(off) | Io(ON) |  | Single |
| Channel | Channel |  | $\Omega$ | V | mA |  | Channel |
| Package | Package |  | $25^{\circ} \mathrm{C}$ | $25^{\circ} \mathrm{C}$ | $25^{\circ} \mathrm{C}$ |  | Packages |
| HSSR-8400 |  | 0.95 | 10 | 400 | 150 | 5 |  |
| HSSR-8060 ${ }^{[1]}$ |  | 1.4 | 0.7 | 60 | 750 | 5 |  |
|  | HSSR-8200 ${ }^{[1]}$ | 1.5 | 200 | 200 | 40 | 1 |  |
|  |  | 6 | 1 | 90 | 800 | 5 | HSSR-7110 ${ }^{[1]}$ |

Note:

1. Technical data are on separate HP publication.

## Ordering Information:

Specify part number followed by Option Number (if desired).


Option data sheets available. Contact your Hewlett-Packard sales representative or authorized distributor for information.

## Schematic



## Outline Drawing

6-Pin DIP Package


DIMENSIONS IN MILLIMETERS AND (INCHES).

## 6-Pin Device Outline Drawing Option \#300 (Gull Wing Surface Mount)



## Thermal Profile (Option \#300)



Figure 1. Maximum Solder Reflow Thermal Profile.
(Note: Use of non-chlorine activated fluxes is recommended.)

## Regulatory Information

The HSSR-8400 has been approved by the following organizations:

## UL

Recognized under UL 508, Component Recognition Program, Industrial Control Switches, File E142465.

## CSA

Approved under CAN/CSA-C22.2 No. 14-95, Industrial Control
Equipment, File LR 87683.

## Insulation and Safety Related Specifications

| Parameter | Symbol | Value | Units | Conditions |
| :--- | :---: | :---: | :---: | :--- |
| Min. External Air Gap <br> (External Clearance) | L(IO1) | 7.0 | mm | Measured from input terminals to output <br> terminals, shortest distance through air |
| Min. External Tracking Path <br> (External Creepage) | L(IO2) | 8.5 | mm | Measured from input terminals to output <br> terminals, shortest distance path along body |
| Min. Internal Plastic Gap <br> (Internal Clearance) | CTI | 0.5 | mm | Through insulation distance, conductor to <br> conductor, usually the direct distance <br> between the photoemitter and photodetector <br> inside the optocoupler cavity |
| Tracking Resistance <br> (Comparative Tracking Index) | CTI | 200 | volts | DIN IEC 112/VDE 0303 PART 1 |
| Isolation Group | IIIa |  | Material Group (DIN VDE 0110, 1/89, Table 1) |  |

Option 300 - surface mount classification is Class A in accordance with CECC 00802.
Absolute Maximum Ratings

Storage Temperature

 Lead Solder Temperature .... $260^{\circ} \mathrm{C}$ for 10 S ( 1.6 mm below seating plane)
Average Input Current - $\mathrm{I}_{\mathrm{F}}$. ..... 20 mA
Repetitive Peak Input Current - $\mathrm{I}_{\mathrm{F}}$(Pulse Width $\leq 1 \mathrm{~ms}$; duty cycle $\leq 50 \%$ )
Transient Peak Input Current - $\mathrm{I}_{\mathrm{F}}$
(Pulse Width $\leq 200 \mu \mathrm{~s}$; duty cycle $\leq 1 \%$ )
Reverse Input Voltage - $\mathrm{V}_{\mathrm{R}}$ ..... 3 V
Input Power Dissipation ..... 40 mW
Output Voltage ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )
Connection $\mathrm{A}-\mathrm{V}_{\mathrm{O}}$ ..... -400 to +400 V
Connection B - $\mathrm{V}_{\mathrm{O}}$ ..... 0 to +400 V
Average Output Current - Figure $3\left(\mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{T}_{\mathrm{C}} \leq 70^{\circ} \mathrm{C}\right)$Connection A - $\mathrm{I}_{\mathrm{O}}$0.15 A
Connection B - $\mathrm{I}_{\mathrm{O}}$ ..... 0.3 A
Single Shot Peak Output Current$\left(100 \mathrm{~ms}\right.$ pulse width, $\left.\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}\right)$Connection A - $\mathrm{I}_{\mathrm{O}}$1.0 A
Connection B - $\mathrm{I}_{\mathrm{O}}$ ..... 2.0 A
Output Power Dissipation ..... $750 \mathrm{~mW}{ }^{[2]}$
Infrared and Vapor Phase Reflow Temperature
(Option \#300)
$\qquad$See Fig. 1, Thermal Profile

## Thermal Resistance

Typical Output MOSFET Junction
to Case $-\theta_{\mathrm{JC}}=55^{\circ} \mathrm{C} / \mathrm{W}$

## Demonstrated ESD Performance

Human Body Model: MIL-STD883 Method 3015.7-16 kV
Machine Model: EIAJ 1988.3.28
Version 2), Test Method 20, Condition C-1200 V

## Recommended Operating Conditions

| Parameter | Symbol | Min. | Max. | Units |
| :--- | :---: | :---: | :---: | :---: |
| Input Current (ON) | $\mathrm{I}_{\mathrm{F}(\mathrm{ON})}$ | 5 | 20 | mA |
| Input Voltage (OFF) | $\mathrm{V}_{\mathrm{F}(\mathrm{OFF})}$ | 0 | 0.8 | Volt |
| Operating Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Output Voltage <br> Connection A | $\mathrm{V}_{\mathrm{O}(\mathrm{OFF})}$ | -370 | 370 | Volt |
| Connection B 0 370 |  |  |  |  |
| Output Current <br> Connection A | $\mathrm{I}_{\mathrm{O}(\mathrm{ON})}$ | -150 | 150 | mA |
| Connection B |  | -300 | 300 |  |

## DC Electrical Specifications

For $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ unless otherwise specified. All Typicals at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

| Parameter | Connection | Sym. | Min. | Typ. | Max. | Units | Test Conditions | Fig. | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Withstand Voltage | A | $\left\|\mathrm{V}_{\mathrm{O}(\mathrm{OFF})}\right\|$ | 400 |  |  | V | $\begin{aligned} & \mathrm{V}_{\mathrm{F}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{O}}=250 \mu \mathrm{~A}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{F}}=0.8 \mathrm{~V}, \mathrm{I}_{\mathrm{O}}=250 \mu \mathrm{~A} \end{aligned}$ | 5 |  |
|  |  |  | 370 |  |  |  |  |  |  |
| Output On- <br> Resistance | A | $\mathrm{R}_{(\mathrm{ON})}$ |  | 6 | 10 | $\Omega$ | $\begin{array}{\|l} \hline \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{I}_{\mathrm{O}}=150 \mathrm{~mA} \\ \text { (pulse duration } \leq 30 \mathrm{~ms} \text { ) }, \\ \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{array}$ | 6,7 | 3 |
|  | B |  |  | 1.5 | 2.5 |  |  |  |  |
|  | A |  |  |  | 15 |  |  |  |  |
|  | B |  |  |  | 3.8 |  |  |  |  |
| Output Leakage Current | A | $\mathrm{I}_{\text {(OFF) }}$ |  | $6 \times 10^{-4}$ | 1.0 | $\mu \mathrm{A}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{F}}=0.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=400 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | 13 |  |
| Output OffCapacitance | A | $\mathrm{C}_{\text {(OFF) }}$ |  | 60 |  | pF | $\begin{aligned} & \mathrm{V}_{\mathrm{F}}=0.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=25 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ | 14 |  |
| Output Offset Voltage | A | $\left\|\mathrm{V}_{\mathrm{OS}}\right\|$ |  | 1 |  | $\mu \mathrm{V}$ | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{I}_{\mathrm{O}}=0 \mathrm{~mA}$ | 18 | 4 |
| Input Reverse Breakdown Voltage |  | $\mathrm{V}_{\mathrm{R}}$ | 3 |  |  | V | $\mathrm{I}_{\mathrm{R}}=100 \mu \mathrm{~A}$ |  |  |
| Input <br> Forward Voltage |  | $\mathrm{V}_{\mathrm{F}}$ | 1.3 | 1.6 | 1.85 | V | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 15 |  |
| Input Diode Temperature Coefficient |  | $\Delta \mathrm{V}_{\mathrm{F}} / \Delta \mathrm{T}_{\mathrm{A}}$ |  | -1.3 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}$ |  |  |
| Input Capacitance |  | $\mathrm{C}_{\text {IN }}$ |  | 72 |  | pF | $\mathrm{V}_{\mathrm{F}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  |  |

## Switching Specifications

For $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ with Connection A, unless otherwise specified. All Typicals at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Test Conditions | Fig. | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Turn On Time | $\mathrm{t}_{\mathrm{ON}}$ |  | 0.5 | 0.95 | ms | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=400 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{O}}=150 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{gathered} \hline 2,8, \\ 9,10, \\ 20,21 \end{gathered}$ | 7 |
|  |  |  |  | 1.2 | ms | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=370 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{O}}=150 \mathrm{~mA} \end{aligned}$ |  |  |
| Turn Off Time | $\mathrm{t}_{\text {OFF }}$ |  | 0.013 | 0.1 | ms | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=400 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{O}}=150 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | $\begin{gathered} \hline 2,8, \\ 11,12, \\ 20,21 \end{gathered}$ |  |
|  |  |  |  | 0.1 |  | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=370 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{O}}=150 \mathrm{~mA} \end{aligned}$ |  |  |
| Output <br> Transient <br> Rejection | $\left\|\mathrm{dV} \mathrm{V}_{0} / \mathrm{dt}\right\|$ | 1000 |  |  | V/us | $\begin{aligned} & \mathrm{V}_{\text {(peak) }}=100 \mathrm{~V}, \mathrm{R}_{\mathrm{M}} \geq 1 \mathrm{M} \Omega, \\ & \mathrm{C}_{\mathrm{M}}=1000 \mathrm{pF}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | 16 |  |
| Input-Output <br> Transient <br> Rejection | $\left\|\mathrm{dV}_{\mathrm{I}-\mathrm{O}} / \mathrm{dt}\right\|$ | 2500 |  |  | V/us | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{I} \text {-O(peak) }}=1000 \mathrm{~V}, \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}} \stackrel{25 \mathrm{pF},}{ } \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | 17 |  |

## Package Characteristics

For $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+70^{\circ} \mathrm{C}$ with Connection A, unless otherwise specified. All Typicals at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Test Conditions | Fig. | Notes |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input-Output <br> Momentary With- <br> stand Voltage* | $\mathrm{V}_{\mathrm{ISO}}$ | 2500 |  |  | V rms | $\mathrm{RH} \leq 50 \%, \mathrm{t}=1 \mathrm{~min}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 5,6 |  |
| Resistance <br> Input-Output | $\mathrm{R}_{\mathrm{I}-\mathrm{O}}$ |  | 100 |  | $\mathrm{G} \Omega$ | $\mathrm{V}_{\mathrm{I}-\mathrm{O}}=500 \mathrm{Vdc}, \mathrm{t}=1 \mathrm{~min}$, <br> $\mathrm{RH}=45 \%$ |  | 5 |
| Capacitance <br> Input-Output | $\mathrm{C}_{\mathrm{I}-\mathrm{O}}$ |  | 1.0 |  | pF | $\mathrm{V}_{\mathrm{I}-\mathrm{O}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | 5 |  |

*The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the VDE 0884 Insulation Characteristics Table (if applicable), your equipment level safety specification, or HP Application Note 1074, "Optocoupler Input-Output Endurance Voltage."

## Notes:

1. The case temperature, $\mathrm{T}_{\mathrm{C}}$, is measured at the center of the bottom of the package.
2. For derating, see Figure 4. The output power $\mathrm{P}_{\mathrm{O}}$ derating curve is obtained when the part is handling the maximum average output current $I_{O}$ as shown in Figure 3.
3. During the pulsed $\mathrm{R}_{\mathrm{ON}}$ measurement ( $\mathrm{I}_{\mathrm{O}}$ duration $\leq 30 \mathrm{~ms}$ ), ambient $\left(\mathrm{T}_{\mathrm{A}}\right)$ and case temperature $\left(\mathrm{T}_{\mathrm{C}}\right)$ are equal.
4. $V_{\mathrm{OS}}$ is a function of $\mathrm{I}_{\mathrm{F}}$, and is defined between pins 4 and 6 , with pin 4 as the
reference. V ${ }_{\text {OS }}$ must be measured in a stable ambient (free of temperature gradients).
5. Device considered a two terminal device: pins 1, 2, and 3 shorted together and pins 4,5 , and 6 shorted together.
6 . This is a momentary withstand proof test. These parts are 100\% tested in production at 3000 V rms , one second.
6. For a faster turn-on time, the optional peaking circuit shown in Figure 2 may be implemented.


Figure 2. Recommended Input Circuit.


Figure 3A. Maximum Average Output Current Rating vs. Ambient Temperature.


Figure 3B. Maximum Average Output Current Rating vs. Case Temperature.


Figure 4. Output Power Derating vs. Case Temperature.


Figure 6. Normalized Typical Output Resistance vs. Temperature.

Figure 7. Typical On State Output I-V Characteristics.


Figure 8. Switching Test Circuit for $\mathrm{t}_{\text {ON }}$, $\mathrm{t}_{\text {OFF }}$.


Figure 9. Typical Turn On Time vs. Temperature.


Figure 10. Typical Turn On Time vs. Input Current.

$T_{A}$ - TEMPERATURE - ${ }^{\circ} \mathbf{C}$

$I_{\text {FONT }}$ - INPUT CURRENT - MA

Figure 11. Typical Turn Off Time vs. Temperature.

Figure 12. Typical Turn Off Time vs Input Current.

$C_{m}$ includes probe and fixture capacitance.
$\mathrm{R}_{\mathrm{m}}$ INCLUDES PROBE AND FIXTURE RESISTANCE.


$$
\frac{d V_{o}}{d t}=\frac{(0.8) V_{\text {PEAK }}}{t_{r}} \text { OR } \frac{(0.8) V_{\text {PEAK }}}{t_{f}}
$$

OVERSHOOT ON $\mathrm{V}_{\text {PEAK }}$ IS TO BE $\leq \mathbf{1 0 \%}$.

Figure 16. Output Transient Rejection Test Circuit.


Figure 17. Input-Output Transient Rejection Test Circuit.

$\mathrm{T}_{\text {jo }}=$ LED JUNCTION TEMPERATURE
$T_{10}=$ FET 1 JUNCTION TEMPERATURE
$\mathrm{T}_{11}=$ FET 1 JUNCTION TEMPERATURE
$\mathrm{T}_{12}=$ FET 2 JUNCTION TEMPERATURE
$\begin{aligned} \mathrm{T}_{12} & =\text { FET } 2 \text { JUNCTION TEMPERATURE } \\ \mathrm{T}_{\mathrm{jd}} & =\text { FET DRIVER JUNCTION TEMPERATURE }\end{aligned}$
$\mathrm{T}_{\mathrm{jd}}=$ FET DRIVER JUNCTION TEMPERATURE
$\mathrm{T}_{\mathrm{c}}=$ CASE TEMPERATURE ( MEASURED AT CENTER OF PACKAGE BOTTOM)
$\mathrm{T}_{\mathrm{A}}=$ AMBIENT TEMPERATURE (MEASURED 15 cm AWAY FROM THE PACKAGE)
$\theta_{C A}=$ CASE-TO-AMBIENT THERMAL RESISTANCE
ALL THERMAL RESISTANCE VALUES ARE IN ${ }^{\circ} \mathrm{C} / \mathrm{W}$.

Figure 18. Voltage Offset Test Setup.


Figure 20. Turn On Time Variation with High Temperature Operating Life.


Figure 21. Turn On Time Variation with Temperature Cycling.

## Applications Information Thermal Model

The steady state thermal model for the HSSR-8400 is shown in Figure 19. The thermal resistance values given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal resistances between the LED and other internal nodes are very large in comparison with the other terms and are omitted for simplicity. The components do, however, interact indirectly through $\theta_{\mathrm{CA}}$, the case-to-ambient thermal resistance. All heat generated flows through $\theta_{\mathrm{CA}}$, which raises the case temperature $\mathrm{T}_{\mathrm{C}}$ accordingly. The value of $\theta_{\mathrm{CA}}$ depends on the conditions of the board design and is, therefore, determined by the designer.

The typical value for each output MOSFET junction-to-case thermal resistance is specified as $55^{\circ} \mathrm{C} / \mathrm{W}$. This is the thermal resistance from one MOSFET junction to the case when power is dissipated equally in the MOSFETs. The power dissipation in the FET Driver is negligible in comparison to the MOSFETs.

## On-Resistance and Derating Curves

The output on-resistance, $\mathrm{R}_{\mathrm{ON}}$, specified in this data sheet, is the resistance measured across the output contact when a pulsed current signal $\left(\mathrm{I}_{\mathrm{O}}=150 \mathrm{~mA}\right)$ is applied to the output pins. The use of a pulsed signal ( $\leq 30 \mathrm{~ms}$ ) implies that each junction temperature is equal to the ambient and case temperatures. The steadystate resistance, $\mathrm{R}_{\mathrm{SS}}$, on the other hand, is the value of the resistance measured across the output contact when a DC current signal is applied to the output pins for a duration sufficient to reach thermal equilibrium. $\mathrm{R}_{\mathrm{SS}}$ includes the effects of the temperature rise of each element in the thermal model.

Derating curves are shown in Figures 3 and 4 . Figure 3 specifies the maximum average output current allowable for a given ambient or case temperature. Figure 4 specifies the output power dissipation allowable for a given case temperature. Above a case temperature of $93^{\circ} \mathrm{C}$, the maximum allowable output current and power dissipation are
related by the expression $\mathrm{R}_{\mathrm{SS}}=\mathrm{P}_{\mathrm{O}}(\max ) /\left(\mathrm{I}_{\mathrm{O}}(\max )\right)^{2}$ from which $\mathrm{R}_{\mathrm{SS}}$ can be calculated. Staying within the safe area assures that the steady state junction temperatures remain less than $125^{\circ} \mathrm{C}$. As an example, for a case temperature of $100^{\circ} \mathrm{C}$, Figure 4 shows that the output power dissipation should be limited to less than 0.5 watts. A check with Figure 3B shows that the output current should be limited to less than 150 mA . This yields an $\mathrm{R}_{\mathrm{SS}}$ of $22 \Omega$.

## Turn On Time Variation

For applications which are sensitive to turn on time, the designer should refer to Figures 20 and 21. These figures show that although there is very little variation in $t_{\text {ON }}$ within most of the population, a portion of the distribution will vary with use. The optional peaking circuit shown in Figure 2 can be used to reduce the total turn on time and, consequently, any associated variation.

